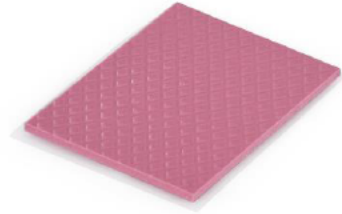


Thermally conductive gap filler pad

TP400 is a 4W/m·K, high thermal conductive gap filler pad that low thermal resistance and excellent electrical insulation at low compression. It can work stably at -40°C~150°C and meet UL94 V-0 flame retardant grade.



Features

- 4.0W/m·K
- High electrical insulation
- Wide usage temperature
- High compression ratio

Typical Applications

- VRMs
- ASICs and DSPs
- Network Communication Devices
- BGAs
- CD ROM/DVD ROM

Typical Properties		
Properties	Attribute	Test Method
Color	Purple	Visual
Thickness(mm)	0.5 to 10.0	ASTM D374
Density (g/cc)	3.1	ASTM D792
Hardness(ShoreOO)	60	ASTM D2240
Weight Loss(%)	≤1.0	Filter paper adsorption @ 25% compression 125°C48H
Usage Temperature (°C)	- 40 to 150	-
Flammability	V-0	UL 94
Shelf Life(month)	12	Temperature <40°C avoid extrusion and exposure to the sun
Electrical		
Breakdown Voltage (kV/mm)	> 6.0	ASTM D149
Volume Resistivity (Ω.cm)	> 10 ¹³	ASTM D257
Dielectric Constant	≤7.5	ASTM D150
Thermal		
Thermal Conductivity (W/m-K)	4.0	ISO22007-2